

PTO/SB/21 (08-00)

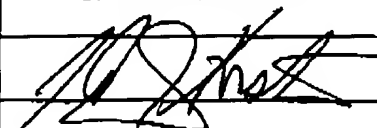
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TRANSMITTAL FORM <i>(to be used for all correspondence after initial filing)</i>	Application Number	09/954,861	
	Filing Date	09/18/2001	
	First Named Inventor	Miller	
	Group Art Unit	2818	
	Examiner Name	Hoang, Quoc Dinh	
Total Number of Pages in This Submission		8	
		Attorney Docket Number	1039.co2

ENCLOSURES (check all that apply)		
<input checked="" type="checkbox"/> Fee Transmittal Form <input type="checkbox"/> Fee Attached <input checked="" type="checkbox"/> Amendment / Reply <input type="checkbox"/> After Final <input type="checkbox"/> Affidavits/declaration(s) <input type="checkbox"/> Extension of Time Request <input type="checkbox"/> Express Abandonment Request <input type="checkbox"/> Information Disclosure Statement <input type="checkbox"/> Certified Copy of Priority Document(s) <input type="checkbox"/> Response to Missing Parts/Incomplete Application <input type="checkbox"/> Response to Missing Parts under 37 CFR 1.52 or 1.53	<input type="checkbox"/> Assignment Papers (for an Application) <input type="checkbox"/> Drawing(s) <input type="checkbox"/> Licensing-related Papers <input type="checkbox"/> Petition <input type="checkbox"/> Petition to Convert to a Provisional Application <input type="checkbox"/> Power of Attorney, Revocation <input type="checkbox"/> Change of Correspondence Address <input type="checkbox"/> Terminal Disclaimer <input type="checkbox"/> Request for Refund <input type="checkbox"/> CD, Number of CD(s) _____	<input type="checkbox"/> After Allowance Communication to Group <input type="checkbox"/> Appeal Communication to Board of Appeals and Interferences <input type="checkbox"/> Appeal Communication to Group (Appeal Notice, Brief, Reply Brief) <input type="checkbox"/> Proprietary Information <input type="checkbox"/> Status Letter <input type="checkbox"/> Other Enclosure(s) (please identify below): <div style="text-align: center;"> <p>PAK RECEIVED</p> <p>DEC 24 2002</p> </div>
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re: Miller, et al.

Serial No: 09/954,861

Filed: 09/18/2001

For: Process for Integrating Dielectric
Optical Coatings into Micro-
Electromechanical Devices

Patent Application

Group: 2816

Examiner: Unknown

AMENDMENT UNDER RULE 111Assistant Commission for Patents
Washington, D.C. 20231

Sir:

In response to the pending Office Action, mailed July 3, 2002 (Paper No. 6),
Applicants hereby amend the above-captioned application and request reconsideration in
view of the following remarks.

In the Claims:*Please amend claim 1, as follows:*

1. (amended) A process for fabricating a deflectable optical MEMS structure
having a dielectric coating, the process comprising:
- forming a device layer;
 - depositing a multilayer reflective dielectric optical coating over the device
layer;
 - depositing a mask layer over the device layer;
 - patterning the mask layer;
 - transferring a pattern of the mask layer into the dielectric coating; and
 - removing at least part of a sacrificial layer to release the device layer.

Please add new claims 16 and 17, as follows: